

**Amendments to the Claims**

The following listing of claims will replace all prior versions of claims in the application.

1-9. (canceled)

10. (currently amended) A heat-curable adhesive composition comprising:  
an ethylene-glycidyl (meth)acrylate copolymer;  
a low density polyethylene;  
an ethylene- $\alpha$ -olefin copolymer; and  
a heat curing agent for said ethylene-glycidyl (meth)acrylate copolymer, wherein  
said heat curing agent comprises a rosin having a carboxyl group in the molecule.

11. (previously presented) The heat-curable adhesive composition of claim 10,  
wherein the minimum density of said low density polyethylene is at least about 0.910 as  
measured according to ASTM D1248-84.

12. (previously presented) The heat-curable adhesive composition of claim 10,  
wherein the maximum density of said low density polyethylene is up to about 0.925 as measured  
according to ASTM D1248-84.

13. (previously presented) The heat-curable adhesive composition of claim 10,  
wherein, in said ethylene- $\alpha$ -olefin copolymer, the polymerization ratio of ethylene to  $\alpha$ -olefin is  
from about 90:10 to about 10:90.

14. (previously presented) The heat curable adhesive composition of claim 10,  
wherein the minimum density of said ethylene- $\alpha$ -olefin copolymer is about 0.850 as measured  
according to ASTM D1248-84.

15. (previously presented) The heat curable adhesive composition of claim 10, wherein the maximum density of said ethylene- $\alpha$ -olefin copolymer is up to about 0.909 as measured according to ASTM D1248-84.

16. cancelled.

17. cancelled.

18. (previously presented) The heat-curable adhesive composition of claim 17, wherein said film has a thickness from about 5 to about 80  $\mu\text{m}$ .

19. (previously presented) The heat-curable adhesive composition of claim 10, wherein, after post-curing, the composition has a dielectric constant of about 2.5 or less, and a dielectric loss tangent of about 0.015 or less when measured at the frequency of about 1 GHz.

20. cancelled.